

Title (en)

METHOD FOR PRODUCING ELECTRONIC DEVICES

Title (de)

VERFAHREN ZUR HERSTELLUNG ELEKTRONISCHER VORRICHTUNGEN

Title (fr)

PROCEDE DE FABRICATION DE DISPOSITIFS ELECTRONIQUES

Publication

EP 3072150 A1 20160928 (FR)

Application

EP 14798851 A 20141113

Priority

- EP 13306583 A 20131119
- EP 2014074541 W 20141113
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Abstract (en)

[origin: WO2015074957A1] The invention relates to a method for producing an electronic device (1) including at least one electronic component (2) in a substrate body, said method including at least one step of transferring said electronic component (2) to a surface (9) of a removable dielectric substrate (5), of delivering a protective resin (7) on said electronic component, and of transferring, onto the protective resin (7), a reinforcement disc (10) having a main front surface with a peripheral contour, characterized in that the protection resin (7) extends up to the peripheral contour of the disc in order to form, together with the disc, the peripheral side edges and the final layer of the substrate body of the device.

IPC 8 full level

H01L 21/56 (2006.01)

CPC (source: EP US)

H01L 21/56 (2013.01 - EP US); **H01L 21/561** (2013.01 - EP US); **H01L 21/563** (2013.01 - EP US); **H01L 21/565** (2013.01 - EP US); **H01L 21/568** (2013.01 - EP US); **H01L 23/3121** (2013.01 - US); **H01L 23/562** (2013.01 - US); **H01L 24/49** (2013.01 - US); **H01L 24/97** (2013.01 - EP US); **H01L 24/48** (2013.01 - EP US); **H01L 2224/48091** (2013.01 - EP US); **H01L 2224/73265** (2013.01 - EP US); **H01L 2924/00014** (2013.01 - EP US); **H01L 2924/181** (2013.01 - EP US)

Citation (search report)

See references of WO 2015074957A1

Designated contracting state (EPC)

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Designated extension state (EPC)

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